





TCAN1046A-Q1

SLLSFL9A - JULY 2021 - REVISED DECEMBER 2021

TCAN1046A-Q1 Automotive Dual CAN FD Transceiver with Standby Mode

1 Features

Texas

INSTRUMENTS

- AEC-Q100 (Grade 1): Qualified for automotive applications
- Two independent high-speed CAN FD transceivers with mode control
- Meets the requirements of ISO 11898-2:2016 physical layer standard
- Functional Safety-Capable
 - Documentation available to aid in functional safety system design
- Support of classical CAN and optimized CAN FD performance at 2, 5, and 8 Mbps
 - Short and symmetrical propagation delays for enhanced timing margin
- Support for 12-V and 24-V battery applications
- Receiver common-mode input voltage: ±12 V
- Protection features:
 - Bus fault protection: ±58 V
 - Undervoltage protection
 - TXD-dominant time-out (DTO)
 - Data rates down to 9.2 kbps
 - Thermal-shutdown protection (TSD)
- Operating modes:
 - Normal mode
 - Low power standby mode supporting remote wake-up request
- Optimized behavior when unpowered
 - Bus and logic pins are high impedance (no load to operating bus or application)
 - Hot-plug capable: power-up and power-down glitch-free operation on bus and RXD output
- Junction temperatures from: -40°C to 150°C
- Available in SOIC (14) and leadless VSON (14) packages (4.5 mm x 3.0 mm) with improved automated optical inspection (AOI) capability

2 Applications

- Automotive and transportation
 - Body control modules
 - Automotive gateway
 - Advanced driver assistance system (ADAS)
 - Infotainment

3 Description

The TCAN1046A-Q1 is a dual high-speed controller area network (CAN) transceiver that meets the physical layer requirements of the ISO 11898-2:2016 high-speed CAN specification.

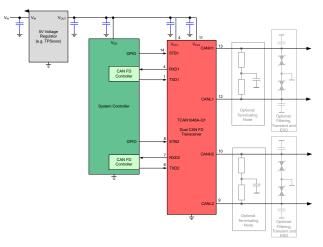
The device supports both classical CAN and CAN FD networks up to 8 megabits per second (Mbps). The device has two CAN FD channels with independent supply, V_{CC1} and V_{CC2} , and mode control, STB1 and STB2 pins, allowing for true independent operation of each CAN channel. The ability to operate each channel independent of one another is important in applications that require redundancy or additional CAN FD channels to act as a back-up in the event of a system failure.

The device includes many protection and diagnostic features including thermal-shutdown (TSD), TXDdominant time-out (DTO), and bus fault protection up to ±58 V. The device has defined failsafe behavior in supply under-voltage or floating pin scenarios.

Device Information

PART NUMBER	PACKAGE ⁽¹⁾	BODY SIZE (NOM)
TCAN1046A-Q1	VSON (DMT) (14)	4.50 mm x 3.00 mm
	SOIC (D) (14)	8.65 mm x 3.91 mm

For all available packages, see the orderable addendum at (1) the end of the data sheet.



Simplified Schematic





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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Cł	nanges from Revision * (July 2021) to Revision A (December\2021)	Page
•	Changed the document status from: Advanced Information to: Production data	1



5 Pin Configuration and Functions

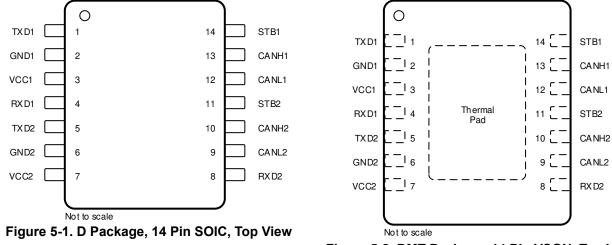


Figure 5-2. DMT Package, 14 Pin VSON, Top View

Pins		Turne	Description	
Name	No.	Туре	Description	
TXD1	1	Digital Input	CAN transmit data input channel 1; integrated pull-up	
GND1	2	GND1	Ground connection, channel 1	
V _{CC1}	3	Supply	5-V supply voltage, channel 1	
RXD1	4	Digital Output	CAN receive data output channel 1; tri-state when $V_{CC} < UV_{VCC}$	
TXD2	5	Digital Input	CAN transmit data input channel 2; integrated pull-up	
GND2	6	GND2	Ground connection, channel 2	
V _{CC2}	7	Supply	5-V supply voltage, channel 2	
RXD2	8	Digital Output	CAN receive data output channel 2; tri-state when $V_{CC} < UV_{VCC}$	
CANL2	9	Bus IO	Low-level CAN bus channel 2 input/output line	
CANH2	10	Bus IO	High-level CAN bus 2 input/output line	
STB2	11	Digital Input	Standby input of channel 2 for mode control; integrated pull-up	
CANL1	12	Bus IO	Low-level CAN bus channel 1 input/output line	
CANH1	13	Bus IO	High-level CAN bus channel 1 input/output line	
STB1	14	Digital Input	Standby input of channel 1 for mode control; integrated pull-up	
Thermal Pad (V	SON only)	_	Connect the thermal pad to the printed circuit board (PCB) ground plane for thermal relief	

Table 5-1. Pin Functions



6 Specifications

6.1 Absolute Maximum Ratings

(1) (2)

		MIN	MAX	UNIT
V _{CC1} , V _{CC2}	Supply voltage	-0.3	6	V
V _{BUS}	CAN Bus I/O voltage CANH1, CANL1, CANH2, CANL2	-58	58	V
V _{DIFF}	Max differential voltage between CANHx and CANLx	-45	45	V
V _{Logic_Input}	Logic input terminal voltage	-0.3	6	V
V _{RXDx}	RXDx output terminal voltage range	-0.3	6	V
I _{O(RXDx)}	RXDx output current	-8	8	mA
TJ	Junction temperature	-40	165	°C
T _{STG}	Storage temperature	-65	150	°C

(1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

(2) All voltage values, except differential I/O bus voltages, are with respect to ground terminal.

6.2 ESD Ratings

				VALUE	UNIT
	Electrostatic discharge		HBM classification level 3A for all pins	±4000	v
V _{ESD}		Human-body model (HBM), per AEC Q100-002 ⁽¹⁾	HBM classification level 3B for global pins CANHx and CANLx with respect to GND	±10000	V
		Charged-device model (CDM), per AEC Q100-011 CDM classification level C5 for all pins		±750	V

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

6.3 ESD Ratings — IEC Specifications

				VALUE	UNIT
	System level Electrostatic discharge		Unpowered contact discharge per ISO 10605 ⁽¹⁾	±8000	V
V _{ESD}			SAE J2962-2 per ISO 10605 Powered Contact Discharge (2)	±8000	V
		CAN bus terminals to GND CANH1, CANL1, CANH2, CANL2 F F F F	SAE J2962-2 per ISO 10605 Powered Air Discharge ⁽²⁾	±15000	V
	Transient voltage per ISO 7637-2 ⁽³⁾		Pulse 1	-100	V
			Pulse 2a	75	V
V _{Tran}			Pulse 3a	-150	V
			Pulse 3b	100	V
	Transient voltage per ISO 7637-3 ⁽⁴⁾		DCC slow transient pulse	±30	V

(1) Tested according to IEC 62228-3:2019 CAN Transceivers

(2) Results given here are specific to the SAE J2962-2 Communication Transceivers Qualification Requirements - CAN. Testing performed by OEM approved independent 3rd party, EMC report available upon request.

- (3) Tested according to IEC 62228-3:2019 CAN Transceivers
- (4) Tested according to SAE J2962-2



6.4 Recommended Operating Conditions

		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.5	5	5.5	V
I _{OH(RXDx)}	RXDx terminal high-level output current	-2			mA
I _{OL(RXDx)}	RXDx terminal low-level output current			2	mA
TJ	Operating junction temperature	-40		150	°C

6.5 Thermal Characteristics

	THERMAL METRIC ⁽¹⁾	TC/	TCAN1046A-Q1		
			DMT (VSON)	UNIT	
R _{0JA}	Junction-to-ambient thermal resistance	75.8	38.1	°C/W	
R _{0JC(top)}	Junction-to-case (top) thermal resistance	35.8	38.7	°C/W	
R _{θJB}	Junction-to-board thermal resistance	37.4	15.0	°C/W	
Ψ _{JT}	Junction-to-top characterization parameter	6.6	2.0	°C/W	
Ψ _{JB}	Junction-to-board characterization parameter	37.0	15.0	°C/W	
R _{0JC(bot)}	Junction-to-case (bottom) thermal resistance	-	5.9	°C/W	

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



6.6 Supply Characteristics

Over recommended operating conditions with $T_J = -40^{\circ}C$ to $150^{\circ}C$ (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
		Dominant One Channel ⁽¹⁾	$\label{eq:transform} \begin{array}{l} TCAN1046A:\ STB1 = STB2 = 0 \ V \\ TXDx = 0 \ V,\ TXDy = V_{CC2} \\ R_{L1} = R_{L2} = 60 \ \Omega, \ C_L = open; \\ See \ Figure \ 7-1 \end{array}$		50	77.5	mA
		Dominant One Channel ⁽¹⁾	$\label{eq:transformation} \begin{array}{l} TCAN1046A: STB1 = STB2 = 0 \ V \\ TXDx = 0 \ V, TXDy = V_{CC2} \\ R_{L1} = R_{L2} = 50 \ \Omega, \ C_L = open; \\ \text{See Figure 7-1} \end{array}$		55	87.5	mA
		Dominant Two channels ⁽¹⁾	TCAN1046A: STB1 = STB2 = 0 V TXDx = TXDy = 0 V $R_{L1} = R_{L2} = 60 \Omega$, C_L = open; See Figure 7-1		95	140	
		Dominant Two channels ⁽¹⁾	$\label{eq:transform} \begin{array}{l} TCAN1046A:\ STB1 = STB2 = 0 \ V \\ TXDx = TXDy = 0 \ V \\ R_{L1} = R_{L2} = 50 \ \Omega, \ C_L = open; \\ See \ Figure \ 7-1 \end{array}$		100	160	
сс	CANx dom with bus fa CANy recessive ⁽¹ CANx dom with bus fa CANy dominant ⁽¹	Recessive Two channels	$ \begin{array}{l} TCAN1046A: STB1 = STB2 = 0 \ V \\ TXDx = V_{CC1}, TXDy = V_{CC2} \\ R_{L1} = R_{L2} = 50 \ \Omega, \ C_L = open; \\ See Figure 7-1 \end{array} $		10	15	mA
		CANx dominant with bus fault CANy recessive ⁽¹⁾ ⁽²⁾	$\label{eq:transform} \begin{array}{l} TCAN1046A:\ STB1 = STB2 = 0 \ V \\ TXDx = V_{CC1},\ TXDy = V_{CC2} \\ CANHx = CANLx = \pm 25 \ V \\ R_{Lx} = \text{open},\ R_{Ly} = 50 \ \Omega,\ C_L = \text{open}; \\ \text{See Figure 7-1} \end{array}$		90	137.5	mA
		CANx dominant with bus fault CANy dominant ⁽¹⁾ ⁽²⁾	$\label{eq:transform} \begin{array}{l} TCAN1046A:\ STB1 = STB2 = 0 \ V \\ TXDx = TXDy = 0 \ V \\ CANHx = CANLx = \pm 25 \ V \\ R_{Lx} = open, \ R_{Ly} = 50 \ \Omega, \ C_L = open; \\ See \ Figure \ 7-1 \end{array}$		135	210	mA
		CANx and CANy dominant with bus fault ⁽¹⁾ ⁽²⁾	TCAN1046A: STB1 = STB2 = 0 V TXDx = TXDy = 0 V CANH1 = CANL1 = ± 25 V CANH2 = CANL2 = ± 25 V R _{Lx} = R _{Ly} = open , C _L = open; See Figure 7-1		170	260	mA
	Supply current Standby mode		TCAN1046A: STB1 = V_{CC1} , STB2 = V_{CC2} TXDx = V_{CC1} , TXDy = V_{CC2} $R_{Lx} = R_{Ly} = 60 \Omega$, C_L = open See Figure 7-1		17.5	32	μA
JV _{cc}	Rising undervoltage detect	ion on V _{CC1/2}			4.2	4.4	V
	Falling undervoltage detect	tion on V _{CC1/2}		3.5	4	4.25	V
V _{HYS(UVC} C)	Hysteresis voltage on UV_C	C1/2			200		mV

(1) TXD1 and TXD2 are interchangeable for TXDx and TXDy

(2) CAN1 and CAN2 are interchangeable for CANx and CANy

6.7 Dissipation Ratings

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
P _D	One channel average power dissipation	V_{CC} = 5 V, T_J = 27°C, R_L = 60Ω, TXD input = 250 kHz 50% duty cycle square wave, C_{L_RXD} = 15 pF	95		mW		
	Normal mode	V_{CC} = 5.5 V, T_J= 150°C, R_L = 60Ω, TXD input = 2.5 MHz 50% duty cycle square wave, C_{L_RXD} = 15 pF		120		mW	
T _{TSD}	Thermal shutdown temperature		175	195	210	°C	
T _{TSD(HYS)}	Thermal shutdown hysteresis			12			



6.8 Electrical Characteristics

Over recommended operating conditions with $T_J = -40^{\circ}C$ to $150^{\circ}C$ (unless otherwise noted), CAN electrical parameters apply to both channels

	PARAMETER		TEST CONDITIONS	MIN	TYP M	٩X	UNIT
Driver Elect	rical Characteristics						
		CANH	STB = 0 V	2.75		1.5	V
V _{O(DOM)}	Dominant output voltage Normal mode	CANL	TXD = 0 V $50 \Omega \le R_L \le 65 \Omega$, C_L = open; See Figure 7-2 and Figure 8-3	0.5	2	25	V
V _{O(REC)}	Recessive output voltage Normal mode	CANH and CANL	$\begin{array}{l} \text{STB = 0 V} \\ \text{TXD = V_{CC}} \\ \text{R}_L = \text{open (no load);} \\ \text{See Figure 7-2 and Figure 8-3} \end{array}$	2	0.5 V _{CC}	3	V
V _{SYM}	Driver symmetry (V _{O(CANH)} + V _{O(CANL)})/V _{CC}		$ \begin{array}{l} \text{STB = 0 V} \\ \text{TXD = 250 kHz, 1 MHz, 2.5 MHz} \\ \text{R}_{\text{L}} = 60 \ \Omega, \ \text{C}_{\text{SPLIT}} = 4.7 \ \text{nF}, \ \text{C}_{\text{L}} = \text{open}; \\ \text{See Figure 7-2 and Figure 8-3} \end{array} $	0.9		1.1	V/V
V _{SYM_DC}	DC output symmetry (V _{CC} - V _{O(CANH)} - V _{O(CANL)})		$\begin{split} \text{STB} &= 0 \ \text{V} \\ \text{R}_L &= 60 \ \Omega, \ \text{C}_L = \text{open}; \\ \text{See Figure 7-2 and Figure 8-3} \end{split}$	-400	4	00	mV
			$\begin{array}{l} \text{STB = 0 V} \\ \text{TXD = 0 V} \\ \text{50 } \Omega \leq \text{R}_{\text{L}} \leq 65 \ \Omega, \ \text{C}_{\text{L}} = \text{open}; \\ \text{See Figure 7-2 and Figure 8-3} \end{array}$	1.5		3	v
	Differential output voltage Normal mode Dominant	CANH - CANL	$\begin{array}{l} \text{STB = 0 V} \\ \text{TXD = 0 V} \\ \text{45 } \Omega \leq \text{R}_{\text{L}} \leq 70 \ \Omega, \ \text{C}_{\text{L}} = \text{open}; \\ \text{See Figure 7-2 and Figure 8-3} \end{array}$	1.4	:	3.3	V
			$\begin{split} & \text{STB = 0 V} \\ & \text{TXD = 0 V} \\ & \text{R}_L = 2240 \ \Omega, \ C_L = \text{open}; \\ & \text{See Figure 7-2 and Figure 8-3} \end{split}$	1.5		5	V
V _{OD(REC)}	Differential output voltage Normal mode CANH - CANL		$\begin{split} & \text{STB = 0 V} \\ & \text{TXD = V_{CC}} \\ & \text{R}_L = 60 \ \Omega, \ C_L = \text{open}; \\ & \text{See Figure 7-2 and Figure 8-3} \end{split}$	-120		12	mV
VOD(REC)	Recessive		$\begin{split} & \text{STB = 0 V} \\ & \text{TXD = V_{CC}} \\ & \text{R}_L = \text{open}, \ & \text{C}_L = \text{open}; \\ & \text{See Figure 7-2 and Figure 8-3} \end{split}$	-50		50	mV
	5	CANH	STB = V _{CC}	-0.1).1	V
V _{O(STB)}	Bus output voltage Standby mode	CANL	R _L = open;	-0.1).1	V
		CANH - CANL	See Figure 7-2 and Figure 8-3	-0.2).2	V
	Short-circuit steady-state ou	tput current,	$\begin{array}{l} \text{STB = 0 V} \\ \text{TXD = 0 V} \\ \text{V}_{(\text{CANH})} = \textbf{-15 V to 40 V, CANL = open;} \\ \text{See Figure 7-7 and Figure 8-3} \end{array}$	-115			mA
IOS(SS_DOM)	DOM) dominant Normal mode		$ STB = 0 V \\ TXD = 0 V \\ V_{(CAN \ L)} = -15 V to 40 V, CANH = open; \\ See Figure 7-7 and Figure 8-3 $			15	mA
IOS(SS_REC)	Short-circuit steady-state output current, recessive Normal mode		$\begin{array}{l} \text{STB = 0 V} \\ \text{TXD = } V_{\text{CC}} \\ -27 \ \text{V} \le V_{\text{BUS}} \le 32 \ \text{V}, \ \text{where} \ \text{V}_{\text{BUS}} = \text{CANH} \\ = \ \text{CANL}; \\ \text{See Figure 7-7 and Figure 8-3} \end{array}$	-5		5	mA
Receiver Ele	ectrical Characteristics						
V _{IT}	Input threshold voltage Normal mode		$\label{eq:stb} \begin{array}{l} \text{STB = 0 V} \\ \text{-12 V} \leq V_{\text{CM}} \leq 12 \text{ V}; \\ \text{See Figure 7-3 and Table 8-5} \end{array}$	500	ç	00	mV
V _{IT(STB)}	Input threshold Standby mode		STB = V_{CC} -12 V ≤ V_{CM} ≤ 12 V; See Figure 7-3 and Table 8-5	400	11	50	mV



6.8 Electrical Characteristics (continued)

Over recommended operating conditions with $T_J = -40^{\circ}C$ to $150^{\circ}C$ (unless otherwise noted), CAN electrical parameters apply to both channels

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{DOM}	Dominant state differential input voltage range Normal mode	STB = 0 V -12 V \leq V _{CM} \leq 12 V; See Figure 7-3 and Table 8-5	0.9		9	v
V _{REC}	Recessive state differential input voltage range Normal mode	STB = 0 V -12 V \leq V _{CM} \leq 12 V; See Figure 7-3 and Table 8-5	-4		0.5	v
V _{DOM(STB)}	Dominant state differential input voltage range Standby mode	STB = V_{CC} -12 V ≤ V_{CM} ≤ 12 V; See Figure 7-3 and Table 8-5	1.15		9	v
V _{REC(STB)}	Recessive state differential input voltage range Standby mode	STB = V_{CC} -12 V ≤ V_{CM} ≤ 12 V; See Figure 7-3 and Table 8-5	-4		0.4	v
V _{HYS}	Hysteresis voltage for input threshold Normal mode	STB = 0 V -12 V \leq V _{CM} \leq 12 V; See Figure 7-3 and Table 8-5		115		mV
V _{CM}	Common mode range Normal and standby modes	See Figure 7-3 and Table 8-5	-12		12	v
I _{LKG(IOFF)}	Unpowered bus input leakage current (measured individually for each channel)	CANH = CANL = 5 V, V _{CC} = GND			5	μA
CI	Input capacitance to ground (CANH or CANL)				20	pF
C _{ID}	Differential input capacitance	$-TXD = V_{CC}$			10	pF
R _{ID}	Differential input resistance	STB = 0 V	40		90	kΩ
R _{IN}	Single ended input resistance (CANH or CANL)	$TXD = V_{CC}$ -12 V ≤ V _{CM} ≤ 12 V	20		45	kΩ
R _{IN(M)}	Input resistance matching [1 – (R _{IN(CANH)} / R _{IN(CANL)})] × 100 %	$V_{(CAN_H)} = V_{(CAN_L)} = 5 V$	-1		1	%
TXD Termin	al (CAN Transmit Data Input)					
V _{IH}	High-level input voltage		0.7 V _{CC}			V
V _{IL}	Low-level input voltage				$0.3 V_{CC}$	V
I _{IH}	High-level input leakage current	$TXD = V_{CC} = 5.5 V$	-2.5	0	1	μA
IIL	Low-level input leakage current	TXD = 0 V V _{CC} = 5.5 V	-200	-100	-20	μA
I _{LKG(OFF)}	Unpowered leakage current	TXD = 5.5 V V _{CC} = 0 V	-1	0	1	μA
CI	Input capacitance	$V_{IN} = 0.4 \times \sin(2 \times \pi \times 2 \times 10^{6} \times t) + 2.5 V$		5		pF
RXD Termin	al (CAN Receive Data Output)					
V _{OH}	High-level output voltage	I _O = –2 mA; See Figure 7-3	0.8 V _{CC}			v
V _{OL}	Low-level output voltage	I _O = 2 mA; See Figure 7-3			0.2 V _{CC}	v
I _{LKG(OFF)}	Unpowered leakage current	RXD = 5.5 V V _{CC} = 0 V	-1	0	1	μA
STB Termin	al (Standby Mode Input)					
VIH	High-level input voltage		0.7 V _{CC}			V
VIL	Low-level input voltage				0.3 V _{CC}	V
I _{IH}	TCAN1046A high-level input leakage current STB	STB = V _{CC} = 5.5 V	-2		2	μA
I _{IL}	TCAN1046A low-level input leakage current STB	STB = 0 V V _{CC} = 5.5 V,	-20		-2	μA
I _{LKG(OFF)}	TCAN1046A unpowered leakage current	STB = 5.5V V _{CC} = 0 V			1	μA



6.9 Switching Characteristics

Over recommended operating conditions with $T_J = -40^{\circ}C$ to $150^{\circ}C$ (unless otherwise noted). Parameters apply to both channels.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Device Switchin	ng Characteristics				•	
t _{PROP(LOOP1)}	Total loop delay Driver input (TXD) to receiver output (RXD), recessive to dominant	$ STB = 0 V \\ R_L = 60 \ \Omega, \ C_L = 100 \ pF, \ C_{L(RXD)} = 15 \ pF; \\ See \ Figure \ 7-4 $		125	210	ns
t _{PROP(LOOP2)}	Total loop delay Driver input (TXD) to receiver output (RXD), dominant to recessive	$ \begin{array}{l} \text{STB = 0 V} \\ \text{R}_{\text{L}} = 60 \; \Omega, \; \text{C}_{\text{L}} = 100 \; \text{pF}, \; \text{C}_{\text{L}(\text{RXD})} = 15 \; \text{pF}; \\ \text{See Figure 7-4} \end{array} $		150	210	ns
t _{MODE}	Mode change time, from normal to standby or from standby to normal	See Figure 7-5			20	μs
t _{WK_FILTER}	Filter time for a valid wake-up pattern		0.5		1.8	μs
t _{WK_TIMEOUT}	Bus wake-up timeout		0.8		6	ms
Driver Switchin	g Characteristics					
t _{pHR}	Propagation delay time, high TXD to driver recessive (dominant to recessive)			80		ns
t _{pLD}	Propagation delay time, low TXD to driver dominant (recessive to dominant)	STB = 0 V R _L = 60 Ω, C _L = 100 pF;		70		ns
t _{sk(p)}	Pulse skew (tpHR - tpLD)	See Figure 7-2		14		ns
t _R	Differential output signal rise time			28		ns
t _F	Differential output signal fall time			50		ns
t _{TXD_DTO}	Dominant timeout	STB = 0 V R_L = 60 Ω, C_L = 100 pF; See Figure 7-6	1.2		4.0	ms



6.9 Switching Characteristics (continued)

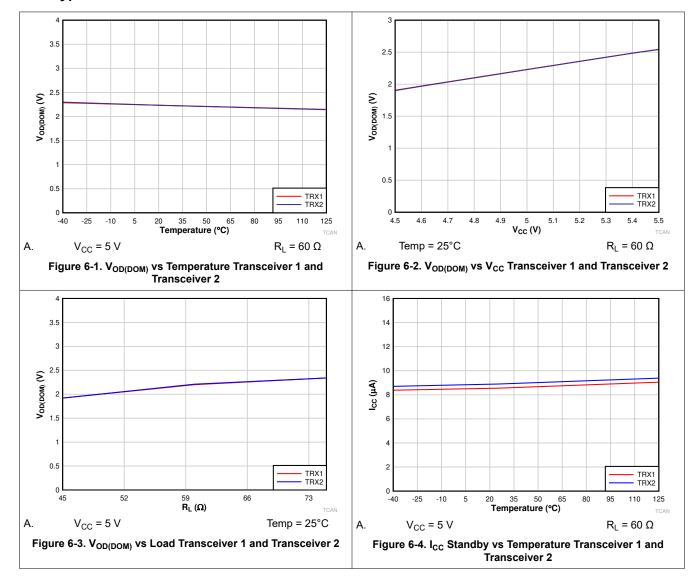
Over recommended operating conditions with $T_J = -40^{\circ}C$ to $150^{\circ}C$ (unless otherwise noted). Parameters apply to both channels.

	PARAMETER	TEST CONDITIONS	MIN	TYP M	X UNIT
Receiver Swit	tching Characteristics				
t _{pRH}	Propagation delay time, bus recessive input to high output (dominant to recessive)			81	ns
t _{pDL}	Propagation delay time, bus dominant input to low output (recessive to dominant)	STB = 0 V $C_{L(RXD)}$ = 15 pF See Figure 7-3		66	ns
t _R	RXD output signal rise time			10	ns
t _F	RXD output signal fall time			10	ns
FD Timing Ch	naracteristics				
	Bit time on CAN bus output pins t _{BIT(TXD)} = 500 ns		450	5	25 ns
t _{BIT(BUS)}	Bit time on CAN bus output pins t _{BIT(TXD)} = 200 ns		160	2)5 ns
	Bit time on CAN bus output pins t _{BIT(TXD)} = 125 ns ⁽¹⁾		85	1	30 ns
	Bit time on RXD output pins t _{BIT(TXD)} = 500 ns	STB = 0 V	410	5	40 ns
t _{BIT(RXD)}	Bit time on RXD output pins t _{BIT(TXD)} = 200 ns	$ \begin{array}{l} R_{L} = 60 \; \Omega, \; C_{L} = 100 \; pF, \; C_{L(RXD)} = 15 \; pF \\ \Delta t_{REC} = t_{BIT(RXD)} - t_{BIT(BUS)} \; ; \end{array} $	130	2	10 ns
	Bit time on RXD output pins t _{BIT(TXD)} = 125 ns ⁽¹⁾	See Figure 7-4	75	1	35 ns
	Receiver timing symmetry t _{BIT(TXD)} = 500 ns		-50		20 ns
t _{REC}	Receiver timing symmetry t _{BIT(TXD)} = 200 ns		-40		10 ns
	Receiver timing symmetry t _{BIT(TXD)} = 125 ns ⁽¹⁾		-40		10 ns

(1) Measured during characterization and not an ISO 11898-2:2016 parameter.

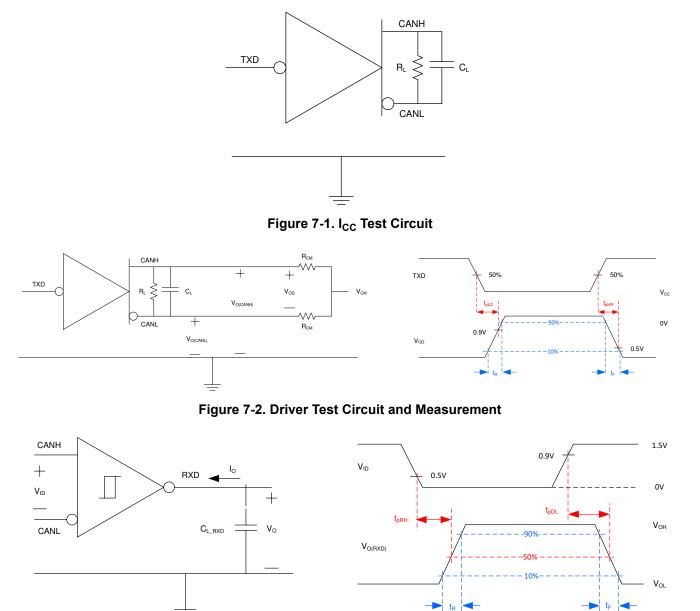


6.10 Typical Characteristics





7 Parameter Measurement Information







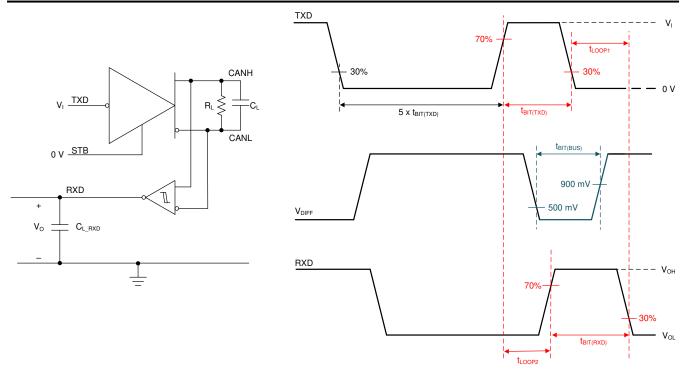
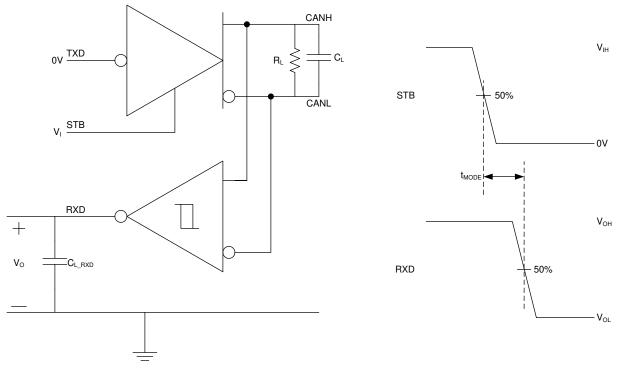


Figure 7-4. Transmitter and Receiver Timing Test Circuit and Measurement









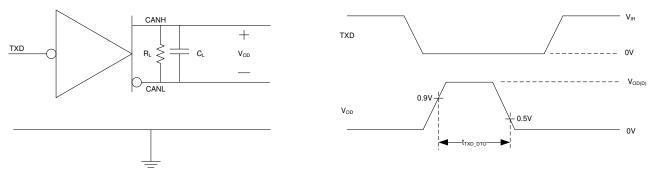


Figure 7-6. TXD Dominant Timeout Test Circuit and Measurement

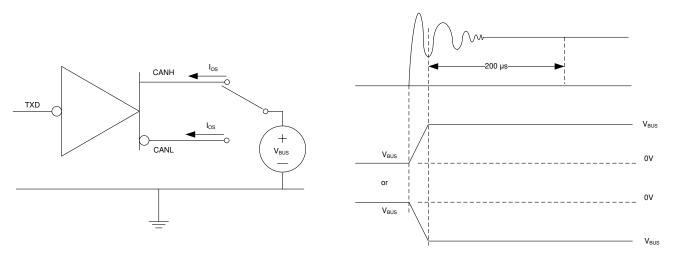


Figure 7-7. Driver Short-Circuit Current Test and Measurement



8 Detailed Description

8.1 Overview

The TCAN1046A-Q1 meets or exceeds the specifications of the ISO 11898-2:2016 high speed CAN (Controller Area Network) physical layer standard. The device has been certified to the requirements of ISO 11898-2:2016 physical layer requirements according to the GIFT/ICT high speed CAN test specification. The transceiver provides a number of different protection features making it ideal for the stringent automotive system requirements while also supporting CAN FD data rates up to 8 Mbps.

The TCAN1046A-Q1 supports the following CAN standards:

- CAN transceiver physical layer standards:
 - ISO 11898-2:2016 High speed medium access unit
 - ISO 11898-5:2007 High speed medium access unit with low-power mode
 - SAE J2284-1: High Speed CAN (HSC) for Vehicle Applications at 125 kbps
 - SAE J2284-2: High Speed CAN (HSC) for Vehicle Applications at 250 kbps
 - SAE J2284-3: High Speed CAN (HSC) for Vehicle Applications at 500 kbps
 - SAE J2284-4: High-Speed CAN (HSC) for Vehicle Applications at 500 kbps with CAN FD Data at 2 Mbps
 - SAE J2284-5: High-Speed CAN (HSC) for Vehicle Applications at 500 kbps with CAN FD Data at 5 Mbps
- EMC requirements:
 - IEC 62228-3 EMC evaluation of transceivers CAN transceivers
 - VeLIO (Vehicle LAN Interoperability and Optimization) CAN and CAN-FD Transceiver Requirements
 - SAE J2962-2 Communication Transceivers Qualification Requirements CAN
- Conformance test requirements:
 - ISO 16845-2 Road vehicles Controller area network (CAN) conformance test plan Part 2: High-speed medium access unit conformance test plan



8.2 Functional Block Diagram

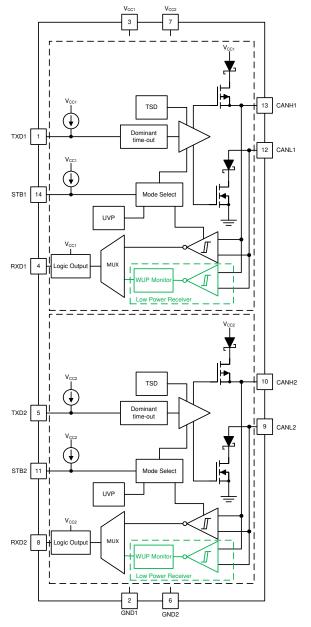


Figure 8-1. Block Diagram



8.3 Feature Description

8.3.1 Pin Description

8.3.1.1 TXD1 and TXD2

TXD1 and TXD2 are the logic-level signals, referenced to V_{CC1} /GND1 domain and V_{CC2} /GND2 domain respectively, from a CAN controller to the device.

8.3.1.2 GND1 and GND2

GND1 and GND2 are ground pins of the two channels integrated within the transceiver, both must be connected to the PCB ground.

8.3.1.3 V_{CC1} and V_{CC2}

V_{CC1} and V_{CC2} provide the 5-V nominal power supply input to their respective CAN transceiver.

8.3.1.4 RXD1 and RXD2

RXD1 and RXD2 are the logic-level output signals from the TCAN1046A-Q1 to a CAN controller.

8.3.1.5 CANH1, CANL1, CANH2, and CANL1

These are the CAN high and CAN low differential bus pins. These pins are connected to the CAN transceiver and the low-voltage WUP CAN receiver.

8.3.1.6 STB1 and STB2 (Standby)

The STB1 and STB2 are input pins used for mode control of the TCAN1046A-Q1. STB1 and STB2 can be supplied from either the system processor or from a static system voltage source. If normal mode is the only intended mode of operation than the STB pins can be tied directly to GND.

8.3.2 CAN Bus States

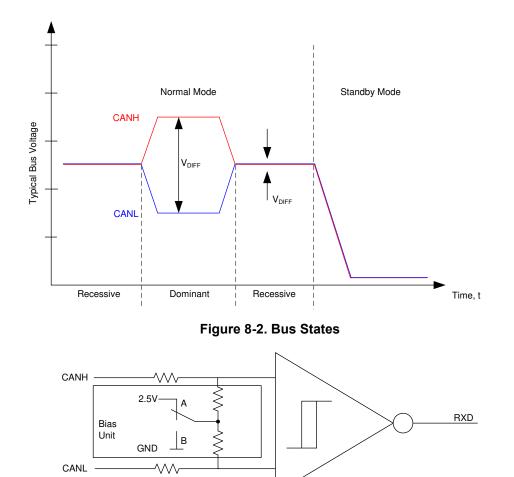
The CAN bus has two logical states during operation: recessive and dominant. See Figure 8-2 and Figure 8-3.

A dominant bus state occurs when the bus is driven differentially and corresponds to a logic low on the TXD1, TXD2, RXD1 and RXD2 pins. A recessive bus state occurs when the bus is biased to $V_{CC}/2$ via the high-resistance internal input resistors (R_{IN}) of the receiver and corresponds to a logic high on the TXD1, TXD2, RXD1 and RXD2 pins.

A dominant state overwrites the recessive state during arbitration. Multiple CAN nodes may be transmitting a dominant bit at the same time during arbitration, and in this case the differential voltage of the bus is greater than the differential voltage of a single driver.

The TCAN1046A-Q1 transceiver implements a low-power standby (STB) mode which enables a third bus state where the bus pins are weakly biased to ground via the high resistance internal resistors of the receiver. See Figure 8-2 and Figure 8-3.





- A. Normal Mode
- B. Standby Mode

Figure 8-3. Simplified Recessive Common Mode Bias Unit and Receiver

8.3.3 TXD Dominant Timeout (DTO)

During normal mode, the only mode where the CAN driver is active, the TXD DTO circuit prevents the local node from blocking network communication in the event of a hardware or software failure where TXD is held dominant longer than the timeout period t_{TXD_DTO} . The TXD DTO circuit is triggered by a falling edge on TXD. If no rising edge is seen before the timeout period of the circuit, t_{TXD_DTO} , the CAN driver is disabled. This frees the bus for communication between other nodes on the network. The CAN driver is reactivated when a recessive signal is seen on the TXD pin, thus clearing the dominant time out. The receiver remains active and biased to $V_{CC}/2$ and the RXD output reflects the activity on the CAN bus during the TXD DTO fault.

The minimum dominant TXD time allowed by the TXD DTO circuit limits the minimum possible transmitted data rate of the device. The CAN protocol allows a maximum of eleven successive dominant bits (on TXD) for the worst case, where five successive dominant bits are followed immediately by an error frame. The minimum transmitted data rate may be calculated using Equation 1.

Minimum Data Rate = 11 bits / t_{TXD} DTO = 11 bits / 1.2 ms = 9.2 kbps

(1)



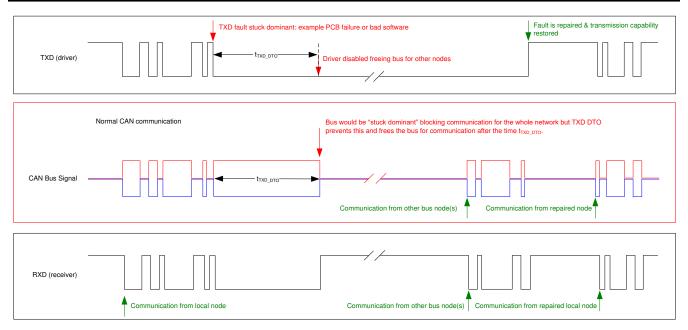


Figure 8-4. Example Timing Diagram for TXD Dominant Timeout

8.3.4 CAN Bus Short-Circuit Current Limiting

The TCAN1046A-Q1 has several protection features that limit the short-circuit current when a CAN bus line is shorted. These include CAN driver current limiting in the dominant and recessive states and TXD dominant state timeout which prevents permanently having the higher short-circuit current of a dominant state in case of a system fault. During CAN communication the bus switches between the dominant and recessive states, thus the short-circuit current may be viewed as either the current during each bus state or as a DC average current. When selecting termination resistors or a common-mode choke for the CAN design the average power rating, I_{OS(AVG)}, should be used. The percentage dominant is limited by the TXD DTO and the CAN protocol which has forced state changes and recessive bits due to bit stuffing, control fields, and interframe space. The protocol allows for a minimum amount of recessive time on the bus even if the data field contains a high percentage of dominant bits.

The average short-circuit current of the bus depends on the ratio of recessive to dominant bits and their respective short-circuit currents. The average short-circuit current may be calculated using Equation 2.

 $I_{OS(AVG)} = \% \text{ Transmit } x \left[(\% \text{ REC}_{Bits } x I_{OS(SS)_{REC}}) + (\% \text{ DOM}_{Bits } x I_{OS(SS)_{DOM}}) \right] + \left[\% \text{ Receive } x I_{OS(SS)_{REC}} \right]$ (2)

Where:

- I_{OS(AVG)} is the average short-circuit current
- % Transmit is the percentage the node is transmitting CAN messages
- % Receive is the percentage the node is receiving CAN messages
- % REC_Bits is the percentage of recessive bits in the transmitted CAN messages
- % DOM_Bits is the percentage of dominant bits in the transmitted CAN messages
- I_{OS(SS) REC} is the recessive steady state short-circuit current
- IOS(SS) DOM is the dominant steady state short-circuit current

This short-circuit current and the possible fault cases of the network should be taken into consideration when sizing the power supply used to generate the transceivers V_{CC} supply.

8.3.5 Thermal Shutdown (TSD)

If the junction temperature of the TCAN1046A-Q1 exceeds the thermal shutdown threshold, T_{TSD} , the device turns off the CAN driver circuitry and blocks the TXD to bus transmission path. The shutdown condition is cleared when the junction temperature of the device drops below T_{TSD} . The CAN bus pins are biased to $V_{CC}/2$



during a TSD fault and the receiver to RXD path remains operational. The TCAN1046A-Q1 TSD circuit includes hysteresis which prevents the CAN driver output from oscillating during a TSD fault.

8.3.6 Undervoltage Lockout

The supply pin, V_{CC} , has undervoltage detection that places the device into a protected state. This protects the bus during an undervoltage event on either supply pin.

V _{cc}	DEVICE STATE	BUS	RXD PIN						
> UV _{VCC}	Normal	Per TXD	Mirrors bus						
< UV _{VCC}	Protected	High impedance ⁽¹⁾	High impedance						

Table 8-1. Undervoltage Lockout	Table	8-1	Undervolta	age Lockout
---------------------------------	-------	-----	------------	-------------

(1) $V_{CC} = GND$, see $I_{LKG(OFF)}$

Once the undervoltage condition is cleared and t_{MODE} has expired the TCAN1046A-Q1 transitions to normal mode and the host controller can send and receive CAN traffic again.

8.3.7 Unpowered Device

The TCAN1046A-Q1 is designed to be an ideal passive or no load to the CAN bus if the device is unpowered. The bus pins were designed to have low leakage currents when the device is unpowered, so they do not load the bus. This is critical if some nodes of the network are unpowered while the rest of the of network remains operational.

The logic pins also have low leakage currents when the device is unpowered, so they do not load other circuits which may remain powered.

8.3.8 Floating pins

The TCAN1046A-Q1 has internal pull-ups on critical pins which place the device into known states if the pin floats. This internal bias should not be relied upon by design though, especially in noisy environments, but instead should be considered a failsafe protection feature.

When a CAN controller supporting open-drain outputs is used, an adequate external pull-up resistor must be chosen. This pull-up resistor allows the TXD output of the CAN controller to maintain acceptable bit time to the input of the CAN transceiver. See Table 8-2 for details on pin bias conditions.

Pin	Pull-up or Pull-down	Comment								
TXD1 and TXD2	PUII-UD	Weakly biases TXD1 and TXD2 towards recessive to prevent bus blockage or TXD DTO triggering								
STB1 and STB2	Pull-up	Weakly biases STB1 and STB2 towards low-power standby mode to prevent excessive system power								

Table 8-2. Pin Bias

8.4 Device Functional Modes

8.4.1 Operating Modes

The TCAN1046A-Q1 has two main operating modes; normal mode and standby mode. Operating mode selection is made by applying a high or low level to the STB1 and STB2 pins on the device.

	Table 6-5. Operating modes									
STB	Device Mode	Driver	Receiver	RXD Pin						
High	Low current standby mode with bus wake-up	Disabled	Low-power receiver and bus monitor enable	High (recessive) until valid WUP is received						
Low	Normal Mode	Enabled	Enabled	Mirrors bus state						

Table 8-3. Operating Modes

8.4.2 Normal Mode

This is the normal operating mode of the TCAN1046A-Q1. The CAN driver and receiver are fully operational and CAN communication is bi-directional. The driver is translating a digital input on the TXD1 and TXD2 inputs



to a differential output on the CANH1, CANL1 and CANH2, CANL2 bus pins. The receiver is translating the differential signal from CANH1, CANL1 and CANH2, CANL2 to a digital output on the RXD1 and RXD2 outputs.

8.4.3 Standby Mode

This is the low-power mode of the TCAN1046A-Q1. The CAN driver and main receiver are switched off and bi-directional CAN communication is not possible. The low-power receiver and bus monitor circuits are enabled to allow for RXD wake-up requests via the CAN bus. A wake-up request is output to RXD1 or RXD2 depending on the channel which received the WUP as shown in Figure 8-5. The local CAN protocol controller should monitor RXD1 and RXD2 for transitions (high-to-low) and reactivate the device to normal mode by pulling the STB1 and STB2 pin low. The CAN bus pins are weakly pulled to GND in this mode; see Figure 8-2 and Figure 8-3.

8.4.3.1 Remote Wake Request via Wake-Up Pattern (WUP) in Standby Mode

The TCAN1046A-Q1 supports a remote wake-up request that is used to indicate to the host controller that the bus is active and the node should return to normal operation.

The device uses the multiple filtered dominant wake-up pattern (WUP) from the ISO 11898-2:2016 standard to qualify bus activity. Once a valid WUP has been received, the wake request is indicated to the controller by a falling edge and low period corresponding to a filtered dominant on the RXD output of the TCAN1046A-Q1.

The WUP consists of a filtered dominant pulse, followed by a filtered recessive pulse, and finally by a second filtered dominant pulse. The first filtered dominant initiates the WUP, and the bus monitor then waits on a filtered recessive; other bus traffic does not reset the bus monitor. Once a filtered recessive is received the bus monitor is waiting for a filtered dominant and again, other bus traffic does not reset the bus monitor reception of the second filtered dominant the bus monitor recognizes the WUP and drives the RXD output low every time an additional filtered dominant signal is received from the bus.

For a dominant or recessive to be considered filtered, the bus must be in that state for more than the t_{WK_FILTER} time. Due to variability in t_{WK_FILTER} the following scenarios are applicable. Bus state times less than $t_{WK_FILTER(MIN)}$ are never detected as part of a WUP and thus no wake request is generated. Bus state times between $t_{WK_FILTER(MIN)}$ and $t_{WK_FILTER(MAX)}$ may be detected as part of a WUP and a wake-up request may be generated. Bus state times greater than $t_{WK_FILTER(MAX)}$ are always detected as part of a WUP, and thus a wake request is always generated. See Figure 8-5 for the timing diagram of the wake-up pattern.

The pattern and t_{WK_FILTER} time used for the WUP prevents noise and bus stuck dominant faults from causing false wake-up requests while allowing any valid message to initiate a wake-up request.

The ISO 11898-2:2016 standard has defined times for a short and long wake-up filter time. The t_{WK_FILTER} timing for the device has been picked to be within the minimum and maximum values of both filter ranges. This timing has been chosen such that a single bit time at 500 kbps, or two back-to-back bit times at 1 Mbps triggers the filter in either bus state. Any CAN frame at 500 kbps or less would contain a valid WUP.

For an additional layer of robustness and to prevent false wake-ups, the device implements a wake-up timeout feature. For a remote wake-up event to successfully occur, the entire WUP must be received within the timeout value $t \le t_{WK_TIMEOUT}$. If not, the internal logic is reset and the transceiver remains in its current state without waking up. The full pattern must then be transmitted again, conforming to the constraints mentioned in this section. See Figure 8-5 for the timing diagram of the wake-up pattern with wake timeout feature.



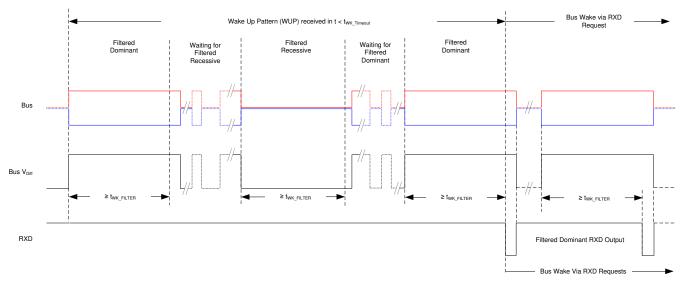


Figure 8-5. Wake-Up Pattern (WUP) with t_{WK_TIMEOUT}

8.4.4 Driver and Receiver Function

The digital logic input and output levels for the TCAN1046A-Q1 are CMOS levels with respect to V_{CC} and are compatible with protocol controllers having 5-V I/O levels.

Table 8-4. Driver F	unction Table
---------------------	---------------

Device Mode	TXD Input	Bus O	utputs	Driven Bus State ⁽²⁾			
Device Mode	TXD IIIput	CANH	CANL	Diven bus State			
Normal	Low	High	Low	Dominant			
normai	High or open	High impedance	High impedance	Biased recessive			
Standby	Standby X ⁽¹⁾		High impedance	Weak pull-down to ground			

(1) X = irrelevant

(2) For bus state and bias see Figure 8-2 and Figure 8-3

Table 8-5. Receiver Function Table Normal and Standby Mode

Device Mode	CAN Differential Inputs V _{ID} = V _{CANH} – V _{CANL}	Bus State	RXD Pin
	V _{ID} ≥ 0.9 V	Dominant	Low
Normal	0.5 V < V _{ID} < 0.9 V	Undefined	Undefined
	V _{ID} ≤ 0.5 V	Recessive	High
	V _{ID} ≥ 1.15 V	Dominant	High
Standby	0.4 V < V _{ID} < 1.15 V	Undefined	Low if a remote wake event
	V _{ID} ≤ 0.4 V	Recessive	occurred
Any	Open (V _{ID} ≈ 0 V)	Open	High



9 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

9.1 Application Information

9.2 Typical Application

The TCAN1046A-Q1 transceiver can be used in applications with a host controller or FPGA that includes the link layer portion of the CAN protocol. Figure 9-1 shows a typical configuration for 5 V controller applications. The bus termination is shown for illustrative purposes.

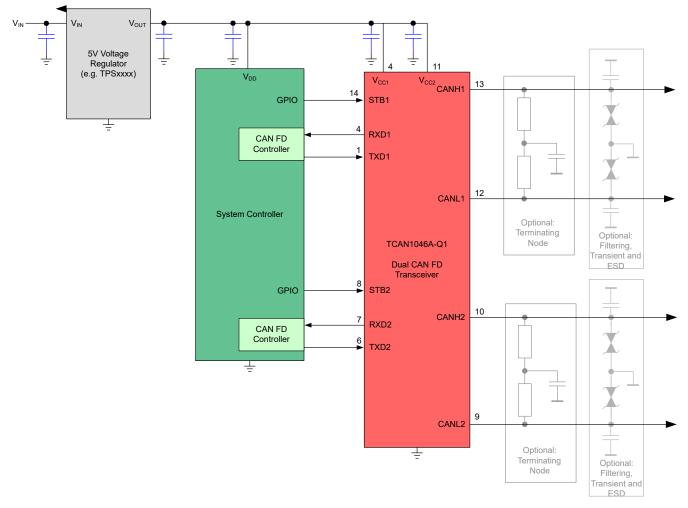


Figure 9-1. Transceiver Application Using 5 V I/O Connections

9.2.1 Design Requirements

9.2.1.1 CAN Termination

Termination may be a single $120-\Omega$ resistor at each end of the bus, either on the cable or in a terminating node. If filtering and stabilization of the common-mode voltage of the bus is desired then split termination may be used,



see Figure 9-2. Split termination improves the electromagnetic emissions behavior of the network by filtering higher-frequency common-mode noise that may be present on the differential signal lines.

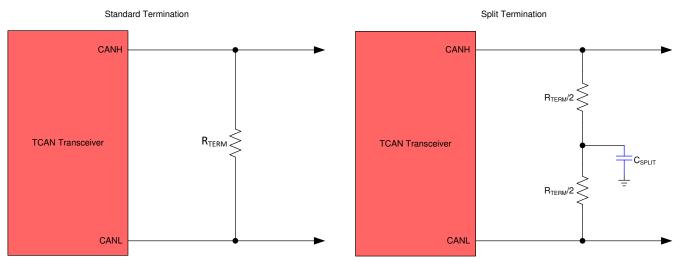


Figure 9-2. CAN Bus Termination Concepts

9.2.2 Detailed Design Procedures

9.2.2.1 Bus Loading, Length and Number of Nodes

A typical CAN application may have a maximum bus length of 40 meters and maximum stub length of 0.3 m. However, with careful design, users can have longer cables, longer stub lengths, and many more nodes to a bus. A high number of nodes requires a transceiver with high input impedance such as the TCAN1046A-Q1.

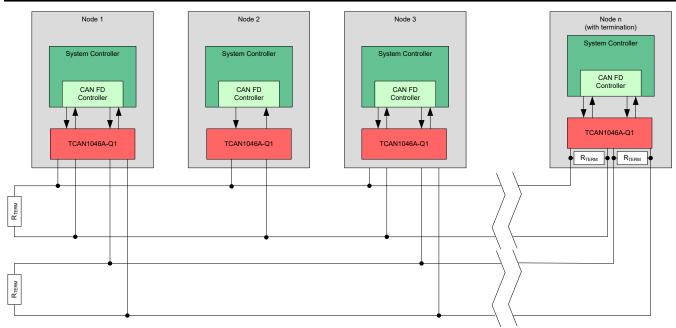
Many CAN organizations and standards have scaled the use of CAN for applications outside the original ISO 11898-2 standard. They made system-level trade off decisions for data rate, cable length, and parasitic loading of the bus. Examples of these CAN systems-level specifications are ARINC 825, CANopen, DeviceNet, SAE J2284, SAE J1939, and NMEA 2000.

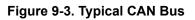
A CAN network system design is a series of tradeoffs. In the ISO 11898-2:2016 specification the driver differential output is specified with a bus load that can range from 50 Ω to 65 Ω where the differential output must be greater than 1.5 V. The TCAN1046A-Q1 is specified to meet the 1.5-V requirement down to 50 Ω and is specified to meet 1.4-V differential output at 45 Ω bus load. The differential input resistance of the TCAN1046A-Q1 is a minimum of 40 k Ω . If 100 TCAN1046A-Q1 transceivers are in parallel on a bus, this is equivalent to a 400- Ω differential load in parallel with the nominal 60 Ω bus termination which gives a total bus load of approximately 52 Ω . Therefore, the TCAN1046A-Q1 theoretically supports over 100 transceivers on a single bus segment. However, for a CAN network design margin must be given for signal loss across the system and cabling, parasitic loadings, timing, network imbalances, ground offsets and signal integrity; thus, a practical maximum number of nodes is often lower. Bus length may also be extended beyond 40 meters by careful system design and data rate tradeoffs. For example, CANopen network design guidelines allow the network to be up to 1 km with changes in the termination resistance, cabling, less than 64 nodes and significantly lowered data rate.

This flexibility in CAN network design is one of the key strengths of the various extensions and additional standards that have been built on the original ISO 11898-2 CAN standard. However, when using this flexibility. the CAN network system must be design for robust network operation.

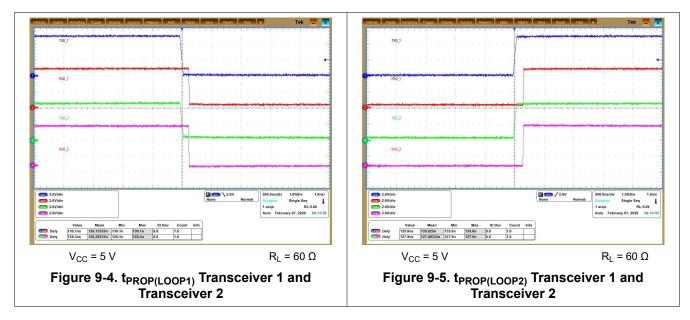


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9.2.3 Application Curves



10 Power Supply Recommendations

The TCAN1046A-Q1 dual transceiver is designed to operate with a main V_{CC1} and V_{CC2} input voltage supply range between 4.5 V and 5.5 V. The V_{CC} supply inputs must be well regulated. A decoupling capacitor, typically 100 nF, should be placed near the CAN transceiver's main V_{CC1} and V_{CC2} supply pins.



11 Layout

Robust and reliable CAN node design may require special layout techniques depending on the application and automotive design requirements. Since transient disturbances have high-frequency content and a wide bandwidth, high-frequency layout techniques should be applied during PCB design.

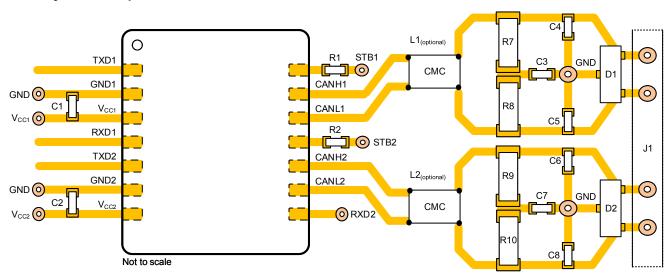
11.1 Layout Guidelines

- Place the protection and filtering circuitry close to the bus connector, J1, to prevent transients, ESD, and noise from propagating onto the board. This layout example shows optional transient voltage suppression (TVS) diodes, D1 and D2, which may be implemented if the system-level requirements exceed the specified rating of the transceiver. This example also shows optional bus filter capacitors C4, C5, C6 and C8.
- Design the bus protection components in the direction of the signal path. Do not force the transient current to divert from the signal path to reach the protection device.
- Decoupling capacitors should be placed as close as possible to the supply pins V_{CC1} and V_{CC2} of the transceiver.
- Use at least two vias for supply and ground connections of bypass capacitors and protection devices to minimize trace and via inductance.

Note

High frequency current follows the path of least impedance and not the path of least resistance.

 This layout example shows how split termination could be implemented on the CAN node. The termination is split into two resistors, R7 and R8 for channel 1, R9 and R10 for channel 2 with the center or split tap of the termination connected to ground via capacitor C3 and C7. Split termination provides common-mode filtering for the bus. See CAN Termination, CAN Bus Short Circuit Current Limiting, and Equation 2 for information on termination concepts and power ratings needed for the termination resistor(s).



11.2 Layout Example

Figure 11-1. Layout Example



12 Device and Documentation Support

12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on Subscribe to updates to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.2 Support Resources

TI E2E[™] support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

12.3 Trademarks

TI E2E[™] is a trademark of Texas Instruments. All trademarks are the property of their respective owners.

12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.5 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TCAN1046ADMTRQ1	ACTIVE	VSON	DMT	14	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 150	1046A	Samples
TCAN1046ADRQ1	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 150	1046A	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

27-Oct-2023

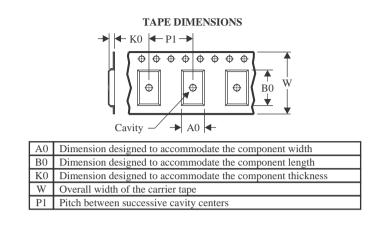


Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TCAN1046ADMTRQ1	VSON	DMT	14	3000	330.0	12.4	3.3	4.8	1.2	8.0	12.0	Q1
TCAN1046ADRQ1	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



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PACKAGE MATERIALS INFORMATION

17-Apr-2023



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TCAN1046ADMTRQ1	VSON	DMT	14	3000	367.0	367.0	35.0
TCAN1046ADRQ1	SOIC	D	14	2500	356.0	356.0	35.0

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



DMT 14

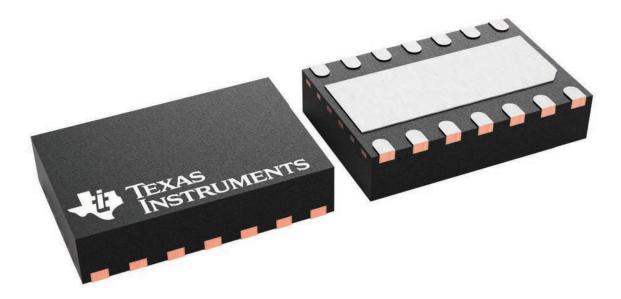
3 x 4.5, 0.65 mm pitch

GENERIC PACKAGE VIEW

VSON - 0.9 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





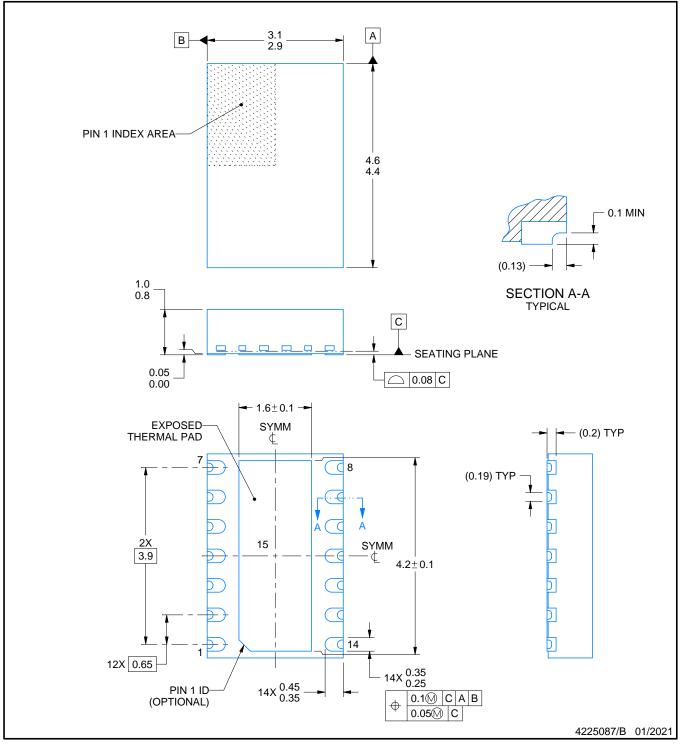
DMT0014B



PACKAGE OUTLINE

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing 2. This drawing is subject to change without notice.
 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

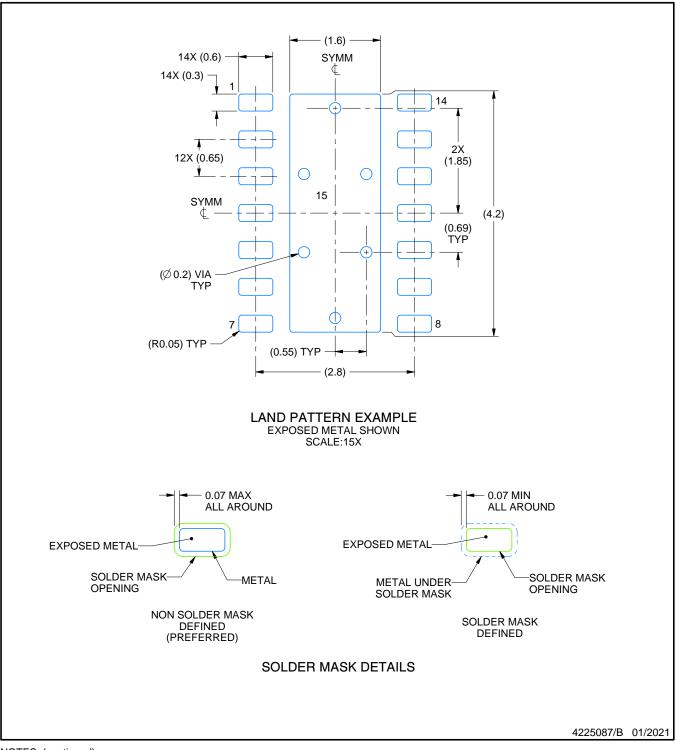


DMT0014B

EXAMPLE BOARD LAYOUT

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

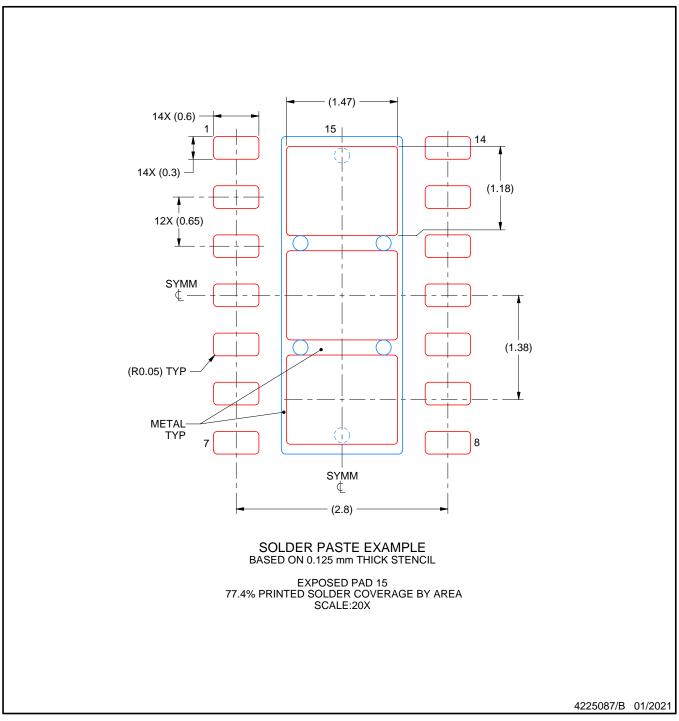


DMT0014B

EXAMPLE STENCIL DESIGN

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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